

Fermi National Accelerator Laboratory Batavia, IL 60510

CMS ME3/1 LOWER CATHODE PANEL COMPONENT SOLDERING TRAVELER

Reference Drawing(s)

Endcap Muon Chamber ME3/1 Final Assembly 5520-ME-368310

Endcap Muon Chamber ME3/1 Cathode Panel Assy Lower Cathode 5520-ME-368314

Budget Code:	Project Code:						
Released by:	Date:						
Prepared by: M. Hubbard, B. Jensen, L. Lee							
Title	Signature	Date					
TD / E&F Process Engineerin	ng						
	Bob Jensen/Designee						
TD / E&F CMS Assembly	Glenn Smith/Designee						
TD / E&F Technological Phys	Sicist Oleg Prokofiev/Designee						
TD / CMS Project Manager							
	Giorgio Apollinari/Designee						

Revision Page

Rev. None

 Revision
 Step No.
 Revision Description
 TRR No.
 Date

 None
 N/A
 Initial Release
 N/A
 04/26/00

CMS ME3/1 Lower Cathode Panel Component Soldering

Panel Serial No._____

Rev. None

Ensure appropriate memos and specific instructions are placed with the traveler before issuing the sub traveler binder to production.

- 1.1 White (Lint Free) Gloves (Fermi stock 2250-1800) or Nitrile Gloves (Fermi stock 2250-2040) shall be worn by all personnel when handling all product parts after the parts have been prepared/cleaned.
- 1.2 All steps that require a sign-off shall include the Technician/Inspectors first initial and full last name.
- 1.3 No erasures or white out will be permitted to any documentation. All incorrectly entered data shall be corrected by placing a single line through the error, initial and date the error before adding the correct data.
- 1.4 All Discrepancy Reports issued shall be recorded in the left margin next to the applicable step.
- 1.5 All personnel performing steps in this traveler must have documented training for this traveler and associated operating procedures.
- 1.6 Personnel shall perform all tasks in accordance with current applicable ES&H guidelines and those specified within the step.
- 1.7 Cover the panel/chamber with Mylar when not being serviced or assembled.
- 1.8 Never hand pass anything over a panel as dropped items may damage the panel.

2.0 Parts Kit List

2.1	Attach the completed	Parts Kit List for the (CMS Cathod	e Panel Component S	Soldering to	this
	traveler. Ensure that th					
	traveler. Verify that the					

Date

Process Engineering/Designee

3.0 <u>Panel Preparation</u>

3.2

Completed

3.1 Acquire the appropriate Lower Cathode Panel as per serial number on the bottom of this traveler. Visually inspect the panel to ensure that there are no damages.

Transport the Lower Cathode Panel using the panel transport cart (MD-368810) to the soldering station.

3.3 Rotate the panel to horizontal with the serial number facing UP and place on the Cathode Panel Component Soldering Station using approved lifting methods.

Technician(s)

Date

X 3.4 Verify all Section 3.0 steps have been properly completed and signed off and the panel is acceptable for further processing.

Date

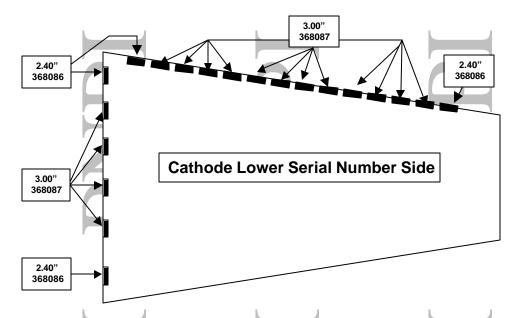
Lead Person

Dai

4.0 <u>Panel Soldering (Strip Side)</u>

Completed

4.1 Using the Grounding Strip Foil Installation templates layout the panel for Grounding Strip installation. Mark foil installation area lightly using a scribe.



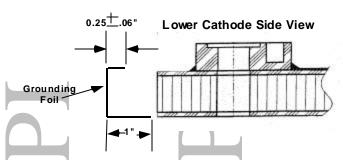
4.1.1 Foil layout scribed on right side of panel from the narrow end (14 locations).

4.1.2 Foil layout scribed on Wide end of panel (6 locations).

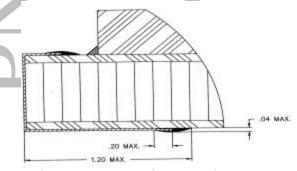
Technician(s) Date

PNPI

Completed



4.2 Form all Grounding Foils to the panel as per Dwg ME-368314 and the above diagram.

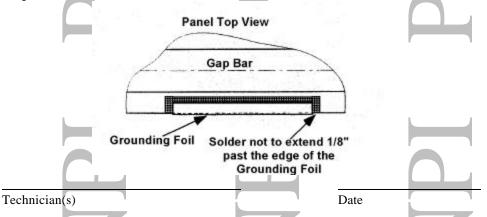


4.3 Place a strip of Almit Solder (MA-368391) under the Strips at the top of the panel. Solder the Strips to the top of the panel Only!! Make sure the solder is smooth when cooled. Continue soldering remaining Grounding Strips tops to the panel until all the Grounding Strips have been soldered to the panel.

Note(s):

When soldering foil to the panel, ensure that no more than 1/8" exceeds past the foil.

Ensure that after soldering of foil, there are no lumps or excess build up of solder on the panel or foil.



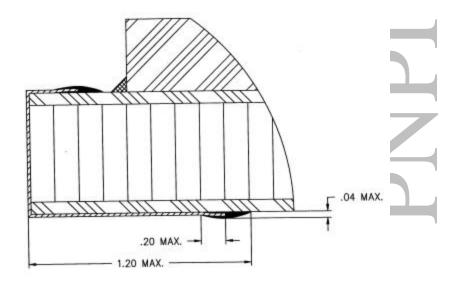
X 4.4 Inspect panel to ensure that all components have been installed and/or soldered correctly in accordance with Lower Cathode Panel DWG 368314 and the panel is acceptable for further processing.

Lead Person Date

5.0 <u>Panel Soldering (Non-strip Side)</u>

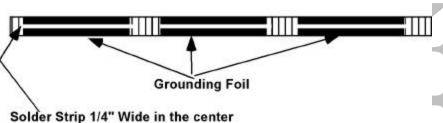
Completed

5.1 Rotate the Panel so the Non-Serial Number side is facing up, and re-install it onto the Panel Component Soldering Station using approved lifting methods.



- 5.2 Trim away the part of the Grounding Strips that are covering over the bolt holes.
- 5.3 Solder a ½" wide strip in the center along the full length of each Grounding Foil.

Panel Side View w/Grounding Foil



Solder Strip 1/4" Wide in the center along the full Length of the Ground Foil

5.4 Transport the completed panel to the Cathode Storage area.

Technician(s) Date

X 5.5 Inspect panel to ensure that all components have been installed and/or soldered correctly in accordance with Lower Cathode Panel DWG 368314 and the panel is acceptable for further processing.

Lead Person Date

CMS ME3/1 Lower Cathode Panel Component Soldering

Panel Serial No.

6.0 <u>Production Complete</u>

XXX	6.1	Process Engineering verify that the CMS ME3/1 Cathode Panel Component Soldering (5520-TR-333466) is accurate and complete. This shall include a review of all steps to ensure that all operations have been completed and signed off. Ensure that all Discrepancy Reports, Nonconformance Reports, Repair/Rework Forms, Deviation Index and dispositions have been reviewed by the Responsible Authority for conformance before being approved.			
		Comments:			
		Process Engineering/Designee		Date	
7.0	Attach	the Process Engineering "OK to Pro	oceed" Tag on the panel.		
		Process Engineering/Designee		Date	
8.0	Procee	ed to the next major assembly operation	on as required.		